



SMD Auto X7R Flex, Ceramic, 2.2 uF, 10%, 25 VDC, X7R, SMD, MLCC, FTCAP, Automotive Grade, 1206, 1.5 mm



General Information				
Series	SMD Auto X7R Flex			
Style	SMD Chip			
Description	SMD, MLCC, FT-CAP, Automotive Grade			
Features	FT-CAP, Automotive Grade			
RoHS	Yes			
Termination	Flexible Termination			
Marking	No			
Qualifications	AEC-Q200			
AEC-Q200	Yes			
Typical Component Weight	41 mg			
Shelf Life	78 Weeks			
MSL	1			

2.2 uF

1206
3.3mm +/-0.4mm
1.6mm +/-0.35mm
1.6mm +/-0.35mm
1.5mm MIN
0.6mm +/-0.25mm
1

	3.5Hill ·/ O.4Hill	Measurement Condition	TRI IZ I.O VIIIIS	
	1.6mm +/-0.35mm	Tolerance	10%	
	1.6mm +/-0.35mm	Voltage DC 25 VDC		
	1.5mm MIN	Dielectric Withstanding Voltage	62.5 VDC -55/+125°C	
	0.6mm +/-0.25mm	Temperature Range		
		Temp. Coefficient	X7R	
5	T&R, 180mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms	
	2000	Dissipation Factor	10% 1 kHz 1.0Vrms	
		Aging Rate	3% Loss/Decade Hour: Referee	

**Specifications** Capacitance

L	3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
W	1.6mm +/-0.35mm	Tolerance	10%
Т	1.6mm +/-0.35mm	Voltage DC	25 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	62.5 VDC
В	0.6mm +/-0.25mm	Temperature Range	-55/+125°C
		Temp. Coefficient	X7R
Packaging Specifications		Capacitance Change with	15%, 1kHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
ackaging Quantity 2000	Dissipation Factor	10% 1 kHz 1.0Vrms	
		Aging Rate	3% Loss/Decade Hour: Referee Time is 48 Hours
		Insulation Resistance	45.5 MOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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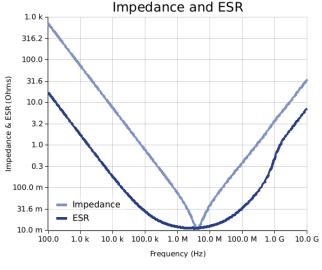


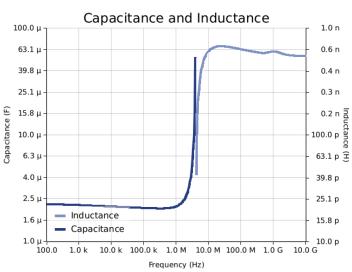


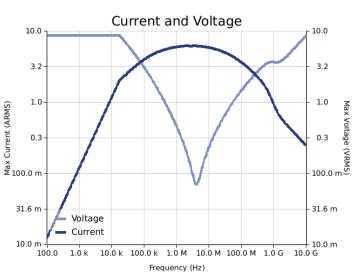
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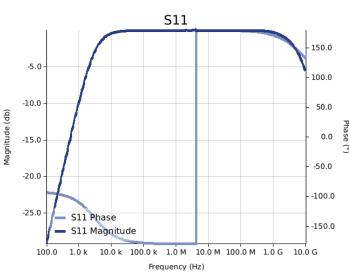
## **Simulations**

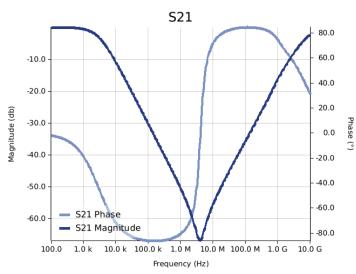
For the complete simulation environment please visit K-SIM.

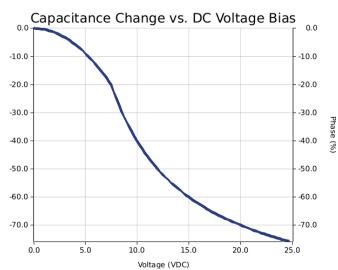










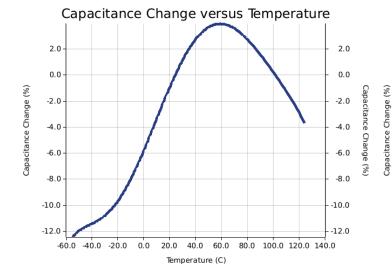


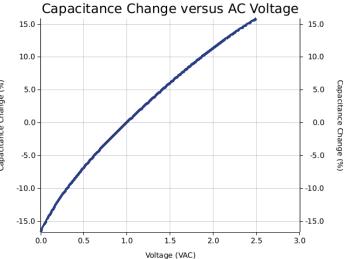
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## C1206X225K3RACAUTO

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## These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for ripple Ripple Currenty votage vs. rrequency plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
  The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
  The effects shown herein are based on measured data from a multiple part sample of the parts in question.
  Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

   Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

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